SLLS095D - SEPTEMBER 1973 - REVISED OCTOBER 1998

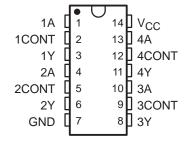
- Input Resistance . . . 3 k Ω to 7 k Ω
- Input Signal Range . . . ±30 V
- Operate From Single 5-V Supply
- Built-In Input Hysteresis (Double Thresholds)
- Response Control that Provides: Input Threshold Shifting Input Noise Filtering
- Meet or Exceed the Requirements of TIA/EIA-232-F and ITU Recommendation V.28
- Fully Interchangeable With Motorola™ MC1489 and MC1489A

description

These devices are monolithic low-power Schottky quadruple line receivers designed to satisfy the requirements of the standard interface between data-terminal equipment and data-communication equipment as defined by TIA/EIA-232-F. A separate response-control (CONT) terminal is provided for each receiver. A resistor or a resistor and bias-voltage source can be connected between this terminal and ground to shift the input threshold levels. An external capacitor can be connected between this terminal and ground to provide input noise filtering.

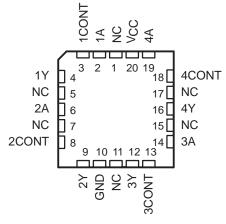
The SN55189 and SN55189A are characterized for operation over the full military temperature range of -55°C to 125°C. The MC1489, MC1489A, SN75189, and SN75189A are characterized for operation from 0°C to 70°C.

SN55189, SN55189A . . . J OR W PACKAGE MC1489, MC1489A, SN75189, SN75189A D, N, OR NS[†] PACKAGE (TOP VIEW)



† The NS package is only available left-end taped and reeled. For SN75189, order SN75189NSR.

SN55189, SN55189A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

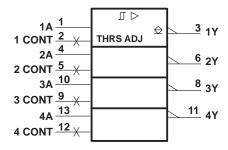


Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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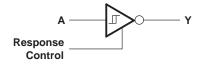


logic symbol†

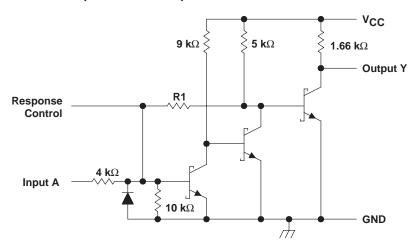


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, J, N, NS, and W packages.

logic diagram (positive logic)



schematic (each receiver)



	MC1489 SN55189 SN75189	MC1489A SN55189A SN75189A
R1	8.4 kΩ	1.84 kΩ

Resistor values shown are nominal.

MC1489, MC1489A, SN55189, SN55189A, SN75189, SN75189A QUADRUPLE LINE RECEIVERS

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NOTES: 1. All voltage values are with respect to the network ground terminal.

DISSIPATION RATING TABLE

PACKAGE	$T_{\mbox{\scriptsize A}} \le 25^{\circ}\mbox{\scriptsize C}$ POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING	T _A = 125°C POWER RATING
D	950 mW	7.6 mW/°C	608 mW	N/A
FK	1375 mW	11.0 mW/°C	880 mW	275 mW
J‡	1375 mW	11.0 mW/°C	880 mW	275 mW
N	1150 mW	9.2 mW/°C	736 mW	N/A
NS	625 mW	4.0 mW/°C	445 mW	N/A
W	1000 mW	8.0 mW/°C	640 mW	200 mW

[‡] In the J package, SN55189 and SN55189A chips are either silver glass or alloy mounted.

recommended operating conditions

	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}	4.5	5	5.5	V
Input voltage, V _I	-25		25	V
High-level output current, IOH			-0.5	mA
Low-level output current, IOL			10	mA
Operating free-air temperature, T _A	0		70	°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

MC1489, MC1489A, SN55189, SN55189A, SN75189, SN75189A QUADRUPLE LINE RECEIVERS

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electrical characteristics over operating free-air temperature range, V_{CC} = 5 V \pm 1% (unless otherwise noted)

	PARAMETER	TEST FIGURE	TEST CONDITIONS†		SN55189 SN55189A		MC1489, MC1489A SN75189 SN75189A			UNIT		
					MIN	TYP‡	MAX	MIN	TYP‡	MAX		
				T _A = 25°C	1	1.3	1.5	1	1.3	1.5		
			'89	$T_A = 0$ °C to 70 °C				0.9		1.6		
V _{IT+}	Positive-going input	1		$T_A = -55^{\circ}C \text{ to } 125^{\circ}C$	0.6		1.9				V	
*11+	threshold voltage	'		T _A = 25°C	1.75	1.9	2.25	1.75	1.9	2.25	•	
			'89A	$T_A = 0$ °C to 70 °C				1.55		2.25		
				$T_A = -55^{\circ}C$ to $125^{\circ}C$	1.30		2.65					
				T _A = 25°C	0.75	1.0	1.25	0.75	1.0	1.25		
VIT-	Negative-going input threshold voltage	1	'89, '89A	$T_A = 0$ °C to 70 °C				0.65		1.25	V	
	un contoia voltago			$T_A = -55^{\circ}C$ to $125^{\circ}C$	0.35		1.6					
Vон	High-level	1	$V_I = 0.75 V$,	$I_{OH} = -0.5 \text{ mA}$	2.6	4	5	2.6	4	5	V	
VOH	output voltage	'	Input open,	$I_{OH} = -0.5 \text{ mA}$	2.6	4	5	2.6	4	5	V	
VOL	Low-level output voltage	1	V _I = 3 V,	I _{OL} = 10 mA		0.2	0.45		0.2	0.45	V	
	High-level	2	V _I = 25 V		3.6		8.3	3.6		8.3	mA	
ΊΗ	input current		V _I = 3 V		0.43			0.43			IIIA	
i	Low-level	2	$V_{I} = -25 \text{ V}$		-3.6		-8.3	-3.6		-8.3	mA	
۱۱۲	input current	2	V _I = −3 V		-0.43			-0.43			IIIA	
los	Short-circuit output current	3				-3			-3		mA	
ICC	Supply current	2	V _I = 5 V,	Outputs open		20	26		20	26	mA	

[†] All characteristics are measured with the response-control terminal open.

switching characteristics, V_{CC} = 5 V, C_L = 15 pF, T_A = 25°C

	PARAMETER	TEST FIGURE	TEST CONDITIONS	MIN	TYP	MAX	UNIT
tPLH	Propagation delay time, low- to high-level output		$R_L = 3.9 \text{ k}\Omega$		25	85	no
tPHL	Propagation delay time, high- to low-level output	4	$R_L = 390 \Omega$		25	50	ns
tTLH	Transition time, low- to high-level output	4	$R_L = 3.9 \text{ k}\Omega$		120	175	
tTHL	Transition time, high- to low-level output		$R_L = 390 \Omega$		10	20	ns

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

PARAMETER MEASUREMENT INFORMATION[†]

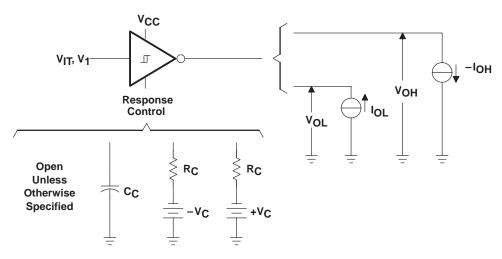
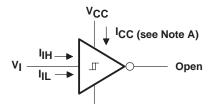


Figure 1. V_{IT+} , V_{IT-} , V_{OH} , V_{OL}



Response Control Open

NOTE A: I_{CC} is tested for all four receivers simultaneously.

Figure 2. I_{IH} , I_{IL} , I_{CC}

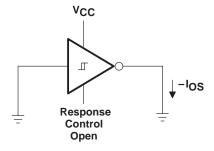
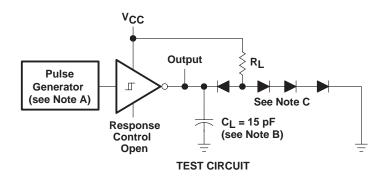
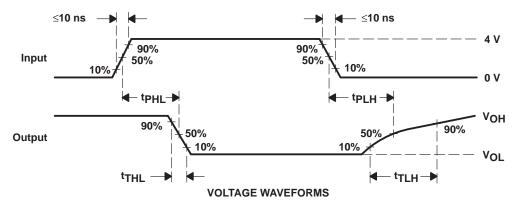


Figure 3. Ios

[†] Arrows indicate actual direction of current flow. Current into a terminal is a positive value.

PARAMETER MEASUREMENT INFORMATION





NOTES: A. The pulse generator has the following characteristics: $Z_0 = 50 \Omega$, $t_W = 500 \text{ ns}$.

- B. C_L includes probe and jig capacitances.
- C. All diodes are 1N3064 or equivalent.

Figure 4. Test Circuit and Voltage Waveforms

TYPICAL CHARACTERISTICS

SN65189, SN75189 OUTPUT VOLTAGE vs

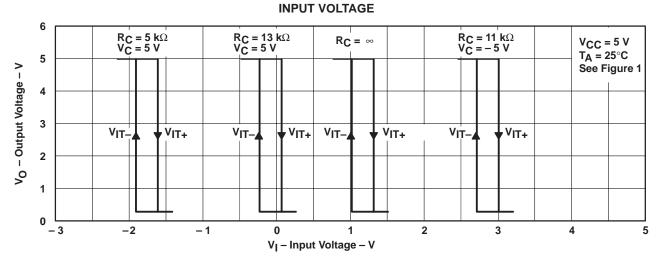


Figure 5

SN65189A, SN75189A OUTPUT VOLTAGE

INPUT VOLTAGE

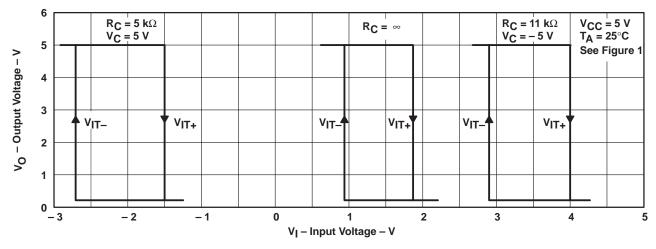


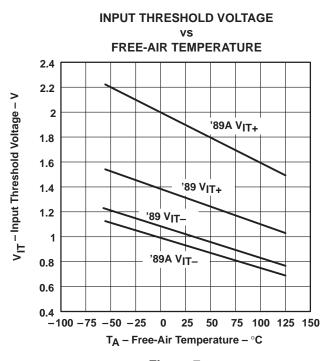
Figure 6

TYPICAL CHARACTERISTICS[†]

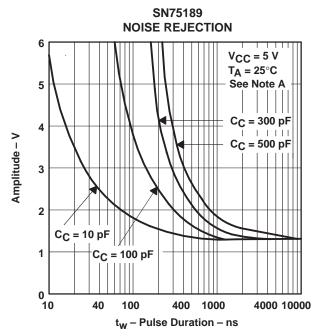
0.2

2

3







NOTE A: Maximum amplitude of a positive-going pulse that, starting from 0 V, will not cause a change in the output level.

SUPPLY VOLTAGE

2
1.8
789A VIT+
789 VIT789 VIT789 VIT789 VIT789 VIT789 VIT789 VIT789 VIT789 VIT-

INPUT THRESHOLD VOLTAGE

Figure 8

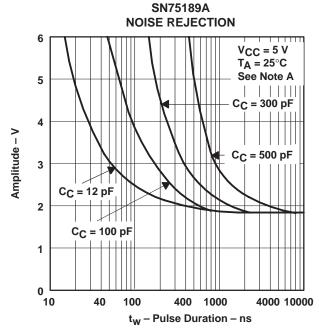
6

V_{CC} - Supply Voltage - V

8

9

10



NOTE A: Maximum amplitude of a positive-going pulse that, starting from 0 V, will not cause a change in the output level.

Figure 9 Figure 10

[†] Data for free-air temperatures below 0°C and above 70°C are applicable to SN55189 and SN55189A circuits only.



TYPICAL CHARACTERISTICS

INPUT CURRENT vs **INPUT VOLTAGE** 10 $V_{CC} = 5 V$ 8 **Control Open** $T_A = 25^{\circ}C$ 6 I_I - Input Current - mA 2 0 -2 -4 -6 -8 -10 5 10 -25 -20 -15 -10 -5 0 15 20

Figure 11

V_I - Input Voltage - V

PACKAGE OPTION ADDENDUM





PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	n MSL Peak Temp ⁽³⁾
5962-86888022A	ACTIVE	LCCC	FK	20	1	None	POST-PLATE	Level-NC-NC-NC
5962-8688802CA	ACTIVE	CDIP	J	14	1	None	A42 SNPB	Level-NC-NC-NC
5962-8688802DA	ACTIVE	CFP	W	14	1	None	A42 SNPB	Level-NC-NC-NC
MC1489AN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
MC1489N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN55189AJ	ACTIVE	CDIP	J	14	1	None	A42 SNPB	Level-NC-NC-NC
SN55189J	OBSOLETE	CDIP	J	14		None	Call TI	Call TI
SN75189AD	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN75189ADR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN75189AN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN75189ANSLE	OBSOLETE	SO	NS	14		None	Call TI	Call TI
SN75189ANSR	ACTIVE	SO	NS	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN75189D	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN75189DR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN75189N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN75189NSR	ACTIVE	SO	NS	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SNJ55189AFK	ACTIVE	LCCC	FK	20	1	None	POST-PLATE	Level-NC-NC-NC
SNJ55189AJ	ACTIVE	CDIP	J	14	1	None	A42 SNPB	Level-NC-NC-NC
SNJ55189AW	ACTIVE	CFP	W	14	1	None	A42 SNPB	Level-NC-NC-NC
SNJ55189FK	OBSOLETE	LCCC	FK	20		None	Call TI	Call TI
SNJ55189J	OBSOLETE	CDIP	J	14		None	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

⁽²⁾ Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder



PACKAGE OPTION ADDENDUM

4-Mar-2005

temperature.

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14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB



FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AB.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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